

Memory Module Data Sheet

ADQVD1A08 DDR2-800+(CL4) 240-Pin EPP U-DIMM 1GB (128M x 64-bits)

General Description:

The ADATA's **ADQVD1A08** is a 128Mx64 bits 1GB(1024MB) DDR2-800(CL4) SDRAM EPP memory module, The SPD is programmed to JEDEC standard latency 800Mbps timing of 5-5-5-18 at 1.8V. The module is composed of eight 128Mx8 bits CMOS DDR2 SDRAMs in FBGA package and one 2Kbit EEPROM in 8pin TSSOP (TSOP) package on a 240pin glass—epoxy printed circuit board.

The **ADQVD1A08** is a Dual In-line Memory Module and intended for mounting onto 240-pins edge connector sockets. Synchronous design allows precise cycle control with the use of system clock. Data I/O transactions are possible on both edges of DQS. Range of operating frequencies, programmable latencies and burst lengths allow the same device to be useful for a variety of high bandwidth, high performance memory system applications.

Features:

- Power supply (Normal): VDD & VDDQ = 1.8V ± 0.1V
- 1.8V (SSTL 18 compatible) I/O
- EPP (Enhanced Performance Profiles) support
- Timing Reference
 - DDR2 800 CL5-5-5-18 at 1.8V
 - DDR2 800 CL4-4-4-12 at 2.0V (EPP Profile 1)
 - DDR2 800 CL4-4-4-11 at 2.0V (EPP Profile 2)
- Burst Length: 4, 8
- Programmable Additive Latency: 0, 1, 2, 3, 4
- Bi-directional, differential data strobe (DQS and /DQS)
- Differential clock input (CK, /CK) operation
- DLL aligns DQ and DQS transition with CK transition
- · Double-data-rate architecture.
- Auto & Self refresh
- Average Refresh period 7.8µs
- Off-Chip Driver (OCD) Impedance Adjustment
- On Die Termination (ODT)
- Lead-free products are RoHS compliant
- EEPROM VDDSPD=3.3V (Typical)
- PCB Height 30.00mm (1.181"), Single sided component
- Clock Cycle Time (tCK):
 - DDR2-800 tCK=2.5ns
- Refresh to Active/Refresh Command Time (tRFC): 127.5ns



Pin Assignment:

| Pin | Front | Pin | Front | Pin | Front | | Pin | Back | Pin | Back | Pin | Back |
|-----|-------|-----|----------|-----|-----------|---|-----|------|-----|----------|-----|--------|
| 1 | VREF | 41 | VSS | 81 | DQ33 | | 121 | VSS | 161 | NC , CB4 | 201 | VSS |
| 2 | VSS | 42 | NC, CB0 | 82 | VSS | | 122 | DQ4 | 162 | NC , CB5 | 202 | DM4 |
| 3 | DQ0 | 43 | NC, CB1 | 83 | /DQS4 | | 123 | DQ5 | 163 | VSS | 203 | NC |
| 4 | DQ1 | 44 | VSS | 84 | DQS4 | | 124 | VSS | 164 | NC , DM8 | 204 | VSS |
| 5 | VSS | 45 | NC,/DQS8 | 85 | VSS | | 125 | DM0 | 165 | NC | 205 | DQ38 |
| 6 | /DQS0 | 46 | NC, DQS8 | 86 | DQ34 | | 126 | NC | 166 | VSS | 206 | DQ39 |
| 7 | DQS0 | 47 | VSS | 87 | DQ35 | | 127 | VSS | 167 | NC , CB6 | 207 | VSS |
| 8 | VSS | 48 | NC/CB2 | 88 | VSS | | 128 | DQ6 | 168 | NC, CB7 | 208 | DQ44 |
| 9 | DQ2 | 49 | NC/CB3 | 89 | DQ40 | | 129 | DQ7 | 169 | VSS | 209 | DQ45 |
| 10 | DQ3 | 50 | VSS | 90 | DQ41 | | 130 | VSS | 170 | VDDQ | 210 | vss |
| 11 | VSS | 51 | VDDQ | 91 | VSS | | 131 | DQ12 | 171 | CKE1 | 211 | DM5 |
| 12 | DQ8 | 52 | CKE0 | 92 | /DQS5 | | 132 | DQ13 | 172 | VDD | 212 | NC |
| 13 | DQ9 | 53 | VDD | 93 | DQS5 | | 133 | VSS | 173 | A15 | 213 | VSS |
| 14 | VSS | 54 | BA2 | 94 | VSS | | 134 | DM1 | 174 | A14 | 214 | DQ46 |
| 15 | /DQS1 | 55 | NC | 95 | DQ42 | | 135 | NC | 175 | VDDQ | 215 | DQ47 |
| 16 | DQS1 | 56 | VDDQ | 96 | DQ43 | | 136 | VSS | 176 | A12 | 216 | VSS |
| 17 | VSS | 57 | A11 | 97 | VSS | | 137 | CK1 | 177 | A9 | 217 | DQ52 |
| 18 | NC | 58 | A7 | 98 | DQ48 | | 138 | /CK1 | 178 | VDD | 218 | DQ53 |
| 19 | NC | 59 | VDD | 99 | DQ49 | | 139 | VSS | 179 | A8 | 219 | VSS |
| 20 | VSS | 60 | A5 | 100 | VSS | 7 | 140 | DQ14 | 180 | A6 | 220 | CK2 |
| 21 | DQ10 | 61 | A4 | 101 | SA2 | | 141 | DQ15 | 181 | VDDQ | 221 | /CK2 |
| 22 | DQ11 | 62 | VDDQ | 102 | NC , TEST | | 142 | VSS | 182 | A3 | 222 | VSS |
| 23 | VSS | 63 | A2 | 103 | VSS | | 143 | DQ20 | 183 | A1 | 223 | DM6 |
| 24 | DQ16 | 64 | VDD | 104 | /DQS6 | | 144 | DQ21 | 184 | VDD | 224 | NC |
| 25 | DQ17 | 65 | VSS | 105 | DQS6 | | 145 | VSS | 185 | CK0 | 225 | VSS |
| 26 | VSS | 66 | VSS | 106 | VSS | | 146 | DM2 | 186 | /CK0 | 226 | DQ54 |
| 27 | /DQS2 | 67 | VDD | 107 | DQ50 | | 147 | NC | 187 | VDD | 227 | DQ55 |
| 28 | DQS2 | 68 | NC | 108 | DQ51 | | 148 | VSS | 188 | A0 | 228 | VSS |
| 29 | VSS | 69 | VDD | 109 | VSS | | 149 | DQ22 | 189 | VDD | 229 | DQ60 |
| 30 | DQ18 | 70 | A10/AP | 110 | DQ56 | | 150 | DQ23 | 190 | BA1 | 230 | DQ61 |
| 31 | DQ19 | 71 | BA0 | 111 | DQ57 | | 151 | VSS | 191 | VDDQ | 231 | VSS |
| 32 | VSS | 72 | VDDQ | 112 | VSS | | 152 | DQ28 | 192 | /RAS | 232 | DM7 |
| 33 | DQ24 | 73 | WE | 113 | /DQS7 | | 153 | DQ29 | 193 | /S0 | 233 | NC |
| 34 | DQ25 | 74 | /CAS | 114 | DQS7 | | 154 | VSS | 194 | VDDQ | 234 | VSS |
| 35 | VSS | 75 | VDDQ | 115 | VSS | | 155 | DM3 | 195 | ODT0 | 235 | DQ62 |
| 36 | /DQS3 | 76 | /S1 | 116 | DQ58 | | 156 | NC | 196 | A13 | 236 | DQ63 |
| 37 | DQS3 | 77 | ODT1 | 117 | DQ59 | | 157 | VSS | 197 | VDD | 237 | VSS |
| 38 | VSS | 78 | VDDQ | 118 | VSS | | 158 | DQ30 | 198 | VSS | 238 | VDDSPD |
| 39 | DQ26 | 79 | VSS | 119 | SDA | | 159 | DQ31 | 199 | DQ36 | 239 | SA0 |
| 40 | DQ27 | 80 | DQ32 | 120 | SCL | | 160 | VSS | 200 | DQ37 | 240 | SA1 |

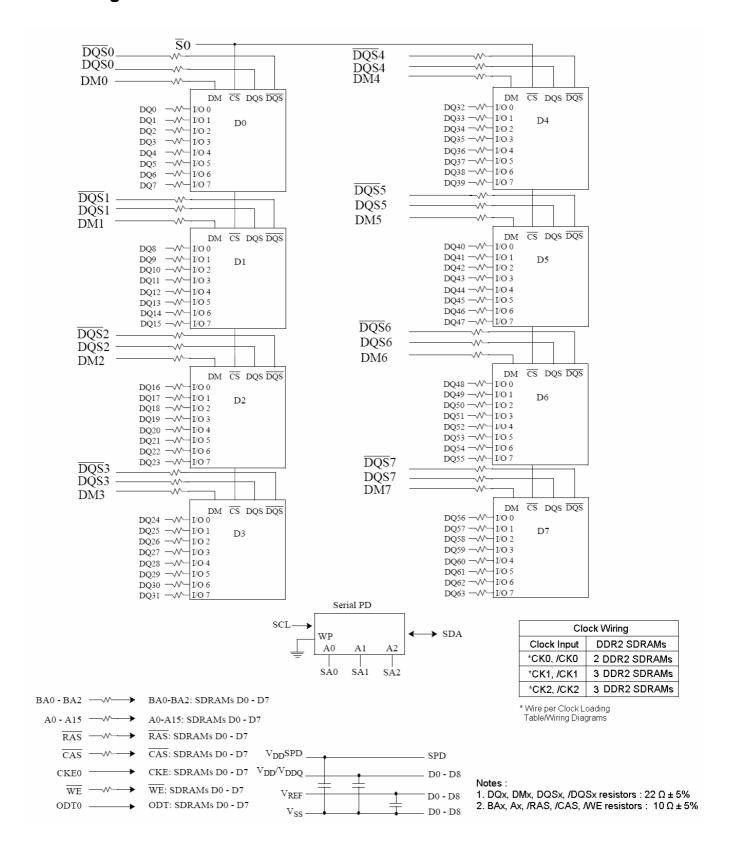


Pin Description:

| PIN | NAME | FUNCTION | | | | |
|---------------------------|------------------------|--|--|--|--|--|
| CK0~CK2, /CK0~/CK2 | System Clock | Active on the positive and negative edge to sample all inputs. | | | | |
| CKE0 | Clock Enable | Masks system clock to freeze operation from the next clock cycle. CKE should be enabled at least on cycle prior new command. Disable input buffers for power down in standby | | | | |
| /\$0 | Chip Select | Disables or Enables device operation by masking or enabling all input except CK, CKE and L(U)DQM | | | | |
| A0~A13 | Address | Row / Column address are multiplexed on the same pins. (Row Address: A0~A13, Column Address: :A0~A9, Auto precharge: A10/AP) | | | | |
| BA0~BA2 | Banks Select | Selects bank to be activated during row address latch time. Selects bank for read / write during column address latch time. | | | | |
| DQ0~DQ63 | Data | Data and check bit inputs / outputs are multiplexed on the same pins. | | | | |
| DQS0~DQS7, /DQS0~/DQS7 | Data Strobe | Bi-directional Data Strobe | | | | |
| DM0~DM7 | Data Mask | Mask input data when DM is high. | | | | |
| /RAS | Row Address Strobe | Latches row addresses on the positive edge of the CK with /RAS low | | | | |
| /CAS | Column Address Strobe | Latches Column addresses on the positive edge of the CK with /CAS low | | | | |
| /WE | Write Enable | Enables write operation and row recharge. | | | | |
| VDD / VSS | Power Supply/Ground | Power and Ground for the input buffers and the core logic. | | | | |
| VREF | Power Supply reference | Power Supply for reference | | | | |
| VDDSPD | SPD Power Supply | Serial EEPROM power Supply | | | | |
| SDA | Serial data I/O | EEPROM serial data I/O | | | | |
| SCL | Serial clock | EEPROM clock input | | | | |
| SA0~SA2 | Address in EEPROM | EEPROM address input | | | | |
| ODT0 | On Die Termination | When high, termination resistance is enabled for all DQ, /DQ and DM pins, assuming the function is enabled in the Extended Mode Register Set. | | | | |
| NC | No Connection | This pin is recommended to be left No Connection on the device. | | | | |



Block Diagram:





Absolute Maximum Ratings:

| Parameter | Symbol | Value | Unit | |
|--|-----------|-------------|------|--|
| Voltage on VDD supply relative to Vss | VDD | -1.0 ~ +2.3 | V | |
| Voltage on VDDQ supply relative to Vss | VDDQ | -0.5 ~ +2.3 | V | |
| Voltage on VDDL supply relative to Vss | VDDQ | -0.5 ~ +2.3 | V | |
| Voltage on any pin relative to Vss | VIN, Vout | -0.5 ~ +2.3 | V | |
| Storage temperature | Тѕтс | -55 ~ +100 | °C | |

Note: DDR2 SDRAM component specification.

Operation Temperature Condition

| Parameter | Symbol | Value | Unit | Note |
|---------------------------------------|--------|-------|------|------|
| DRAM Component Case Temperature Range | TC | 0~+95 | J | 1 |

Note: (1) If the DRAM case temperature is above 85°C, the Auto-Refresh command interval has to be reduced to tREFI=3.9us.

DC Operating Condition:

Voltage referenced to Vss = 0V, VDD&VDDQ=1.8V±0.1V, Tc = 0 to 85 °C

| Parameter | Symbol | Min | Max | Unit | Note |
|---------------------------|--------|-------------|-------------|------|------|
| Supply Voltage | VDD | 1.7 | 1.9 | V | 4,5 |
| | VDDSPD | 1.7 | 3.6 | V | |
| Supply Voltage for DLL | VDDL | 1.7 | 1.9 | V | 4 |
| Supply Voltage for Output | VDDQ | 1.7 | 1.9 | V | 4,5 |
| Input Reference Voltage | VREF | 0.49 x VDDQ | 0.51 x VDDQ | V | 1,2 |
| Termination Voltage | VTT | VREF - 0.04 | VREF + 0.04 | V | 3 |

Note: (1) There is no specific device VDD supply voltage requirement for SSTL_1.8 compliance. However under all conditions VDDQ must be less than or equal to VDD.

- (2) The value of VREF may be selected by the user to provide optimum noise margin in the system. Typically, the value of VREF is expected to be about 0.5 x VDDQ of the transmitting device and VREF is expected to track variations in VDDQ.
- (3) Peak to peak ac noise on VREF may not exceed +/- 2% VREF (ac).
- (4) VTT of transmitting device must track VREF of receiving device.
- (5) VDDQ tracks with VDD, VDDL tracks with VDD. AC parameters are measured with VDD, VDDQ and VDDL tied together.



Package Dimensions:

